EPISTAR

ES-CABLV35A

InGaN Venus Blue LED Chip

> Mechanical Specification:

(1) Dimension

- Chip size: 35 mil x 35 mil (890 \pm 25 μ m x 890 \pm 25 μ m)

- Thickness: 5.9 mil (150 \pm 10 μ m)

- P bonding pad: 3.9 mil (100 \pm 10 μ m)

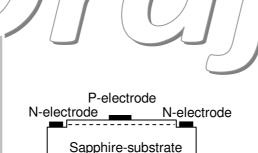
- N bonding pad: 3.9 mil (100 \pm 10 μ m)

(2) Metallization

- Topside P electrode (x2): Au alloy

- Topside N electrode (x2): Au alloy

- Backside metal. Au alloy



Backside metal

Features:

- · High radiant flux
- · Long operation life
- · Lambertain radiation

Applications:

- · Replacement lamps
- Architectural lighting
- · Residential lighting

> Electro-optical Characteristics at 25°C: (1)

Parameter	Symbol		Condition	Min.	Тур.	Max.	Unit
Forward Voltage	Vf1		If = 10μA	1.6	-	-	V
	Vf2		If = 350mA	-	3.3	3.5	V
Reverse Current	Ir		Vr = 5V	-	-	2.0	μΑ
Dominant Wavelength ⁽²⁾	λd		If = 350mA	455	-	465	nm
Spectra Half-width	Δλ		If = 350mA	-	25	-	nm
Radiant Flux ⁽³⁾⁽⁴⁾	Ро	M51	- If = 350mA	300	-	320	mW
		M52		320	-	340	

Note:

⁽¹⁾ ESD protection during chip handling is recommended.

⁽²⁾ Basically, the wavelength span is 10nm; however, customers' special requirements are also welcome.

⁽³⁾ Radiant flux is determined by using an Au-plated TO-can header without an encapsulant.

⁽⁴⁾ Radiant flux measurement allows a tolerance of $\pm 15\%$.

> Absolute Maximum Ratings:

Parameter	Symbol	Condition	Rating	Unit
Forward DC Current	If	Ta = 25°C	≤ 500	mA
Reverse Voltage	Vr	Ta = 25°C	≤ 5	V
Junction Temperature	Tj	-	≤ 115	°C
Storage Temperature	Tstg	Chip	-40 ~ +85	°C
		Chip-on-tape/storage	5 ~ 35	°C
		Chip-on-tape/transportation	-20 ~ +65	°C
Temperature during Packaging	-	-	280(<10sec)	°C

Note: Maximum ratings are package dependent. The above maximum ratings were determined using a Metal Core Printed Circuit Board (MCPCB) without an encapsulant. Stresses in excess of the absolute maximum ratings such as forward current and junction temperature may cause damage to the ED.

Characteristic Curves:

Fig.1 - Relative luminous Intensity vs. Forward Current

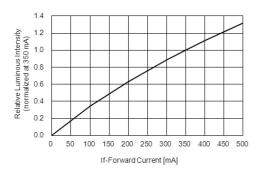


Fig.3 – Relative Intensity (@350mA) vs. Ambient Temperature

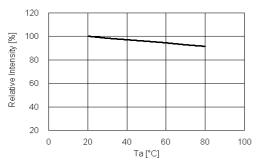


Fig.5 – Dominant Wavelength (@350mA) vs. Ambient Temperature

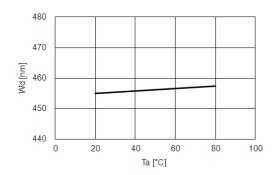


Fig.2 – Forward Current vs. Forward Voltage

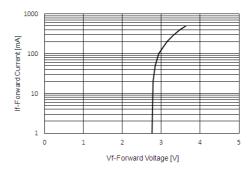


Fig.4 – Forward Voltage (@350mA) vs. Ambient Temperature

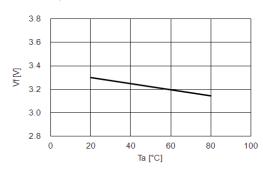


Fig.6 – Maximum Driving Forward DC Current vs. Ambient Temperature (De-rating based on Tj max. = 115°C)

